

A

B

C

D

A

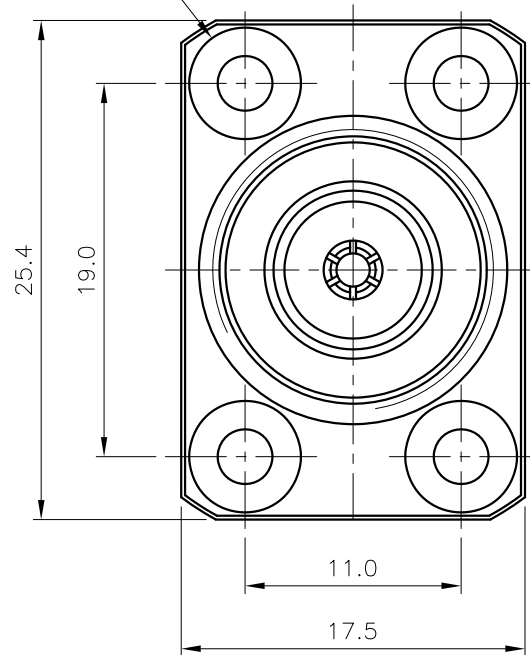
B

C

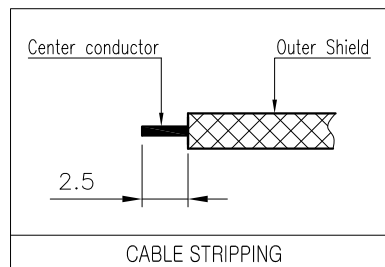
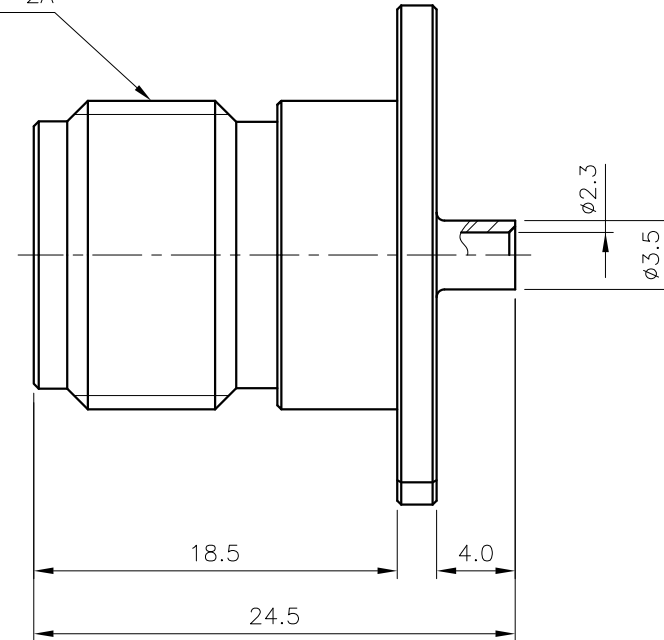
D

REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration	S.Y.EUN	I.C.KIM	2018.05.15.	
1	[설번No.202004-0004] 고객사 요청으로 인한 바디 식별용 삭제	S.Y.EUN	I.C.KIM	2020.04.22.	
2	반 회전방지 개선 뒤시텍 및 널링부 외경 사이즈 변경 절연체 내경 변경	S.H.KIM		2023.09.21.	

4- ϕ 2.8 DRILL
90° DCS DP1.5



5/8-24 UNEF-2A



2	4	INSULATOR	1	TEFLON		DIN02882-N/2 DIN02882-N/1
	3	CONTACT	1	BeCu C17300	Gold Plate	DCT03817-5/4 DCT03817-5/3
2	2	INSERT BODY	1	MBsBD C3604BD-F	Gold Plate	DBD04293-5/2
	1	BODY	1	SUS303	Passivate	DBD04292-5/2
1	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2023. 09. 21.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL _____		CHECKED BY			TITLE N50 CABLE JS-4H 85
		DRAWN BY S.H.KIM			
FINISH _____	SCALE 2.5/1	UNIT mm			A4
					REVISION 2 SHEET 1 of 1